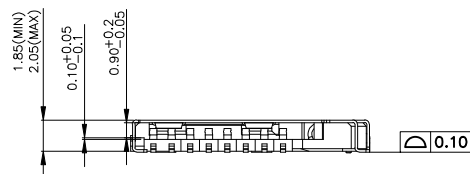
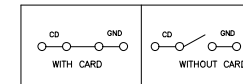
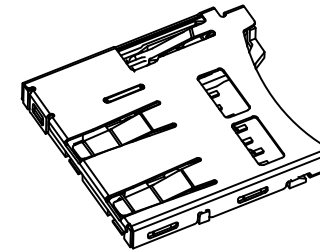
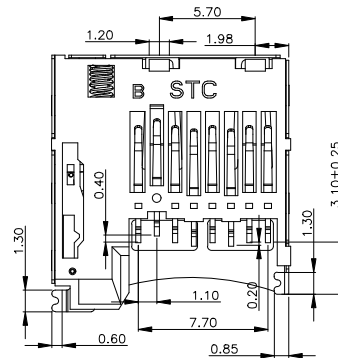
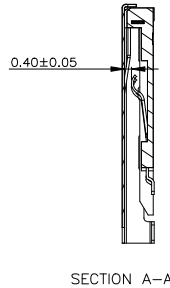
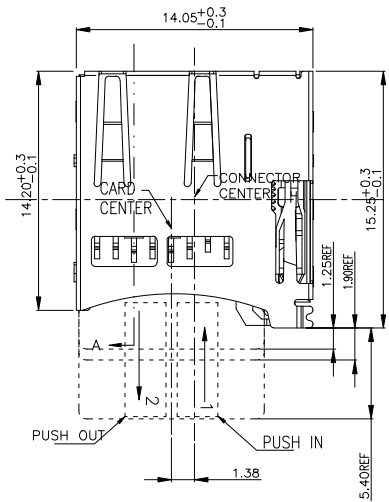
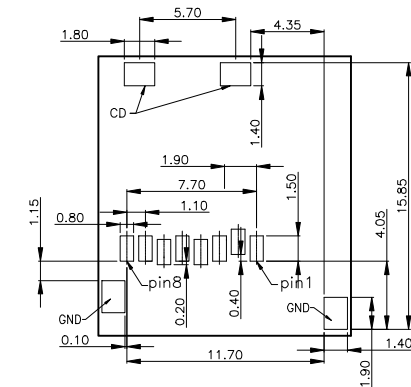




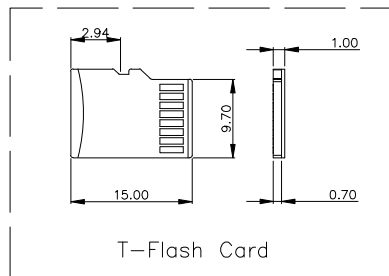
REV.	ECN NO OR DESCRIPTION	REVISED	DATE



PIN NO.	NAME	TYPE	DESCRIPTION
1	DAT2	I/O/PP	DATE LINE(BIT2)
2	CD/DAT3	I/O/PP	CARD DETECT DATE LIN(BIT3)
3	CMD	PP	COMMAND RESPONSE
4	VDD	S	SUPPLY VOLTAGE
5	CLX	I	CLOCK
6	VSS	S	SUPPLY VOLTAGE GROUND
7	DAT0	I/O/PP	DATE LINE(BIT0)
8	DAT1	I/O/PP	DATE LINE(DIT1)
9	CD	CD	CD



RECOMMENDED P.C.B HOLE LAYOUT  
COMPONENT SIDE VIEW(TOLERANCE: +/-0.05)



- NOTES:
- MATERIAL:  
HOUSING: HIGH TEMPERATURE THERMOPLASTIC  
UL94V\_0,COLOR:BLACK.  
CONTACT: COPPER ALLOYS.  
COVER: COPPER ALLOYS OR STEEL.
  - PLATING:  
UNDERPLATE: NICKEL.  
CONTACT AREA: GOLD OVER NICKEL.  
SOLDER AREA: TIN OVER NICKEL.
  - MULTIMEDIA CARD COMPATIBLE

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS: X :±0.5 X.X :±0.20 X.XX :±0.10		ANGLES: X :±2° X.X :±1°		TITLE T-FLASH CARD PUSH PUSH B TYPE 内焊	
DWN	xiong	TF-011			
CHKD	lee	SCALE:1:1	UNIT: mm		
APVD	wang	SIZE: A4	SHEET:10F 1	REV: A4	
CUSTOMER COPY					